

C1210C751MATACTU

Aliases (C1210C751MATAC7800) SMD Comm X8G HT150C, Ceramic, 750 pF, 20%, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 1210, 1.5 mm



General Information		
Series	SMD Comm X8G HT150C	
Style	SMD Chip	
Description	SMD, MLCC, High Temperature, Ultra-Stable	
Features	High Temperature, Ultra-Stable	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Typical Component Weight	30 mg	
Shelf Life	78 Weeks	
MSL	1	

750 pF

Dimensions	
Chip Size	1210
L	3.2mm +/-0.2mm
W	2.5mm +/-0.2mm
Т	0.78mm +/-0.10mm
S	1.5mm MIN
В	0.5mm +/-0.25mm

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S	1.5mm MIN
В	0.5mm +/-0.25mm
Packaging Specifications	

L	3.2mm +/-0.2mm	Measurement Condition	1 MHz 1.0Vrms
W	2.5mm +/-0.2mm	Tolerance	20%
Т	0.78mm +/-0.10mm	Voltage DC	250 VDC
S	1.5mm MIN	Dielectric Withstanding Voltage	625 VDC
В	0.5mm +/-0.25mm	Temperature Range	-55/+150°C
		Temp. Coefficient	X8G
Packaging Specifications		Capacitance Change with 30 ppm, Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Packaging	T&R, 180mm, Plastic Tape		
Packaging Quantity	4000	Dissipation Factor	0.1% 1 MHz 1.0Vrms
		Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
		Insulation Resistance	100 GOhms

Specifications

Capacitance

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